Application No. 10/800,417 INFÖRMATIØN DISCLOSURE Filing Date March 11, 2004 Chantal J. Arena First Named Inventor STATEMENT BY APPLICANT 2812 Art Unit Examiner Unknown (Multiple sheets used when necessary) Attorney Docket No. ASMEX.446A SHEET 1 OF 3

U.S. PATENT DOCUMENTS									
Examiner Initials	Cite No.	Document Number Number - Kind Code (if known) Example: 1,234,567 B1	Publication Date MM-DD-YYYY	Name of Patentee or Applicant	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear				
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Examiner Signature

Date Considered October 14, 2005

\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

T<sup>1</sup> - Place a check mark in this area when an English language Translation is attached.

INFORMATION DISCLOSURE
STATEMENT BY APPLICANT

(Multiple sheets used when necessary)
SHEET 2 OF 3

	1 10/05/00 Equivalent
Application No.	10/800,417
Filing Date	March 11, 2004
First Named Inventor	Chantal J. Arena
Art Unit	2812
Examiner	Unknown
Attorney Docket No.	ASMEX.446A

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Examiner Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	τ¹					
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MAR 1 4 2005	Application No.	10/800,417
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STATEMENT BY APPLICANT	First Named Inventor	Chantal J. Arena
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(Multiple sheets used when necessary)	Examiner	Unknown
SHEET 3 OF 3	Attorney Docket No.	ASMEX.446A

		NON PATENT LITERATURE DOCUMENTS	
Examiner Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T <sup>1</sup>
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